



Microwave/Millimeter Wave Circuits and Systems for Emerging Wireless Applications

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Message from the Guest Editor

Dear Colleagues,

Mobile communications have changed people's daily lifestyles in recent years. Microwave and millimeter-wave circuits and systems play key roles in evolutions of wireless applications such as wireless communication systems (e.g., 4G/5G mobile communication), industrial automation, radar communication, and driverless automotive safety. Emerging applications in wireless (e.g., Beyond 5G, Internet of Things (IoT), Internet of Space (IoS)) demand highly versatile microwave/millimeter circuits and systems.

The purpose of this Special Issue is to host recent research findings in the area of RF/wireless communication that focus on microwave/millimeter active and passive circuits and systems. This issue will serve as a valuable resource for both academic and industrial researchers to understand the state of the art of microwave/millimeter-wave circuit design for emerging applications.





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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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